



Product Change Notification

Change Notification #: 818421-00

Change Title: Select Boxed Intel® Pentium® Gold G7400, Processor, Boxed Intel® Celeron® Processor G6900, PCN 818421-00, Product Material, Thermal Solution Update

Date of Publication: March 20, 2024

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 01, 2024
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Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- Products will be boxed with Intel Laminar Cooler RM1 instead of Intel Laminar Cooler RS1 after implementation date July 01, 2024.

Customer Impact of Change and Recommended Action:

There is no change to the form, fit or function of the thermal solution, therefore no action is needed by customers.

Individual retail package will be slightly heavier (91 grams or 0.2 lbs.)

Customers may see a mix of products until inventory has been depleted.

Products Affected/Intel Ordering Codes:

Marketing Name	Stepping	MM#	Product Code	Spec Code	Platform
Boxed Intel® Pentium® Gold G7400 Processor	H0	99ATJN	BXC80715G7400	S RL66	DESKTOP
Boxed Intel® Pentium® Gold G7400 Processor	H0	99ATJH	BX80715G7400	S RL66	DESKTOP
Boxed Intel® Celeron® Processor G6900	H0	99ATJP	BX80715G6900	S RL67	DESKTOP
Boxed Intel® Celeron® Processor G6900	H0	99ATJW	BXC80715G6900	S RL67	DESKTOP

PCN Revision History:

Date of Revision:
March 20, 2024

Revision Number:
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Reason:
Originally Published PCN



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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com